

Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Resistant to Latch-Up
- Halogen Free, RoHS Compliant

Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

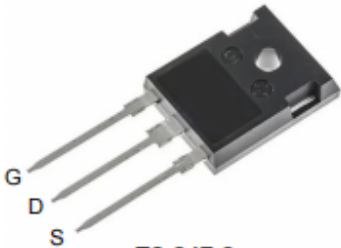
Applications

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC converters
- Motor Drive
- Boost Converter

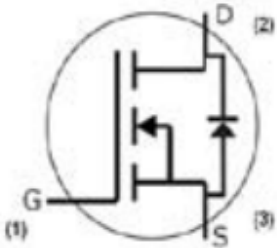
| Part Number | Package  | Marking         |
|-------------|----------|-----------------|
| HMM85N170T  | TO-247-3 | HMM85N170T XXXX |



|                     |               |
|---------------------|---------------|
| $V_{DS}$            | 1700 V        |
| $I_D @ 25^{\circ}C$ | 85 A          |
| $R_{DS(on)}$        | 28 m $\Omega$ |



TO-247-3  
Package



Maximum Ratings (T<sub>C</sub> = 25 °C unless otherwise specified)

| Symbol         | Parameter                                  | Value       | Unit        | Test Conditions                                        | Note    |
|----------------|--------------------------------------------|-------------|-------------|--------------------------------------------------------|---------|
| $V_{DSmax}$    | Drain - Source Voltage                     | 1700        | V           | $V_{GS} = 0\text{ V}$ , $I_D = 100\text{ }\mu\text{A}$ |         |
| $V_{GSmax}$    | Gate - Source Voltage                      | -15/+25     | V           | Absolute maximum values, AC (f > 1 Hz)                 |         |
| $V_{GSop}$     | Gate - Source Voltage                      | -5/+20      | V           | Recommended operational values                         |         |
| $I_D$          | Continuous Drain Current                   | 85          | A           | $V_{GS} = 20\text{ V}$ , $T_C = 25^{\circ}C$           | Fig. 19 |
|                |                                            | 59.5        |             | $V_{GS} = 20\text{ V}$ , $T_C = 100^{\circ}C$          |         |
| $I_{D(pulse)}$ | Pulsed Drain Current                       | 255         | A           | Pulse width $t_p$ limited by $T_{jmax}$                | Fig. 22 |
| $P_D$          | Power Dissipation                          | 535         | W           | $T_C = 25^{\circ}C$ , $T_J = 150^{\circ}C$             | Fig. 20 |
| $T_J, T_{stg}$ | Operating Junction and Storage Temperature | -55 to +175 | $^{\circ}C$ |                                                        |         |
| $T_L$          | Max Solder Temperature                     | 300         | $^{\circ}C$ | 1/8" from case for 5s                                  |         |

## THERMAL CHARACTERISTICS

| Parameter                                | Symbol          | Max  | Unit |
|------------------------------------------|-----------------|------|------|
| Junction-to-Case – Steady State (Note 1) | $R_{\theta JC}$ | 0.28 | °C/W |

## ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|-----------|--------|----------------|-----|-----|-----|------|
|-----------|--------|----------------|-----|-----|-----|------|

### OFF CHARACTERISTICS

|                                                           |                   |                                                        |                           |      |         |                   |
|-----------------------------------------------------------|-------------------|--------------------------------------------------------|---------------------------|------|---------|-------------------|
| Drain-to-Source Breakdown Voltage                         | $V_{(BR)DSS}$     | $V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$               | 1700                      | –    | –       | V                 |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | $V_{(BR)DSS}/T_J$ | $I_D = 1\text{ mA}$ , referenced to $25^\circ\text{C}$ | –                         | 0.46 | –       | V/°C              |
| Zero Gate Voltage Drain Current                           | $I_{DSS}$         | $V_{GS} = 0\text{ V}, V_{DS} = 1700\text{ V}$          | $T_J = 25^\circ\text{C}$  | –    | –       | 100 $\mu\text{A}$ |
|                                                           |                   |                                                        | $T_J = 175^\circ\text{C}$ | –    | –       | 1 mA              |
| Gate-to-Source Leakage Current                            | $I_{GSS}$         | $V_{GS} = +25/-15\text{ V}, V_{DS} = 0\text{ V}$       | –                         | –    | $\pm 1$ | $\mu\text{A}$     |

### ON CHARACTERISTICS (Note 2)

|                               |              |                                                                    |     |      |     |                  |
|-------------------------------|--------------|--------------------------------------------------------------------|-----|------|-----|------------------|
| Gate Threshold Voltage        | $V_{GS(TH)}$ | $V_{GS} = V_{DS}, I_D = 20\text{ mA}$                              | 1.8 | 2.75 | 4.3 | V                |
| Recommended Gate Voltage      | $V_{GOP}$    |                                                                    | –5  | –    | +20 | V                |
| Drain-to-Source On Resistance | $R_{DS(on)}$ | $V_{GS} = 20\text{ V}, I_D = 60\text{ A}, T_J = 25^\circ\text{C}$  | –   | 28   | 40  | $\text{m}\Omega$ |
|                               |              | $V_{GS} = 20\text{ V}, I_D = 60\text{ A}, T_J = 175^\circ\text{C}$ | –   | 57   | –   |                  |
| Forward Transconductance      | $g_{FS}$     | $V_{DS} = 20\text{ V}, I_D = 60\text{ A}$                          | –   | 31   | –   | S                |

### CHARGES, CAPACITANCES & GATE RESISTANCE

|                              |              |                                                                     |   |      |   |             |
|------------------------------|--------------|---------------------------------------------------------------------|---|------|---|-------------|
| Input Capacitance            | $C_{ISS}$    | $V_{GS} = 0\text{ V}, f = 1\text{ MHz}, V_{DS} = 800\text{ V}$      | – | 4230 | – | $\text{pF}$ |
| Output Capacitance           | $C_{OSS}$    |                                                                     | – | 200  | – |             |
| Reverse Transfer Capacitance | $C_{RSS}$    |                                                                     | – | 10   | – |             |
| Total Gate Charge            | $Q_{G(TOT)}$ | $V_{GS} = -5/20\text{ V}, V_{DS} = 800\text{ V}, I_D = 60\text{ A}$ | – | 200  | – | $\text{nC}$ |
| Gate-to-Source Charge        | $Q_{GS}$     |                                                                     | – | 77   | – |             |
| Gate-to-Drain Charge         | $Q_{GD}$     |                                                                     | – | 46   | – |             |
| Gate-Resistance              | $R_G$        | $f = 1\text{ MHz}$                                                  | – | 5.8  | – | $\Omega$    |

### SWITCHING CHARACTERISTICS

|                         |              |                                                                                                               |   |      |   |               |
|-------------------------|--------------|---------------------------------------------------------------------------------------------------------------|---|------|---|---------------|
| Turn-On Delay Time      | $t_{d(ON)}$  | $V_{GS} = -5/20\text{ V}, V_{DS} = 1200\text{ V}, I_D = 60\text{ A}, R_G = 2\text{ }\Omega$<br>inductive load | – | 47   | – | $\text{ns}$   |
| Rise Time               | $t_r$        |                                                                                                               | – | 18   | – |               |
| Turn-Off Delay Time     | $t_{d(OFF)}$ |                                                                                                               | – | 121  | – |               |
| Fall Time               | $t_f$        |                                                                                                               | – | 13   | – |               |
| Turn-On Switching Loss  | $E_{ON}$     |                                                                                                               | – | 1311 | – | $\mu\text{J}$ |
| Turn-Off Switching Loss | $E_{OFF}$    |                                                                                                               | – | 683  | – |               |
| Total Switching Loss    | $E_{tot}$    |                                                                                                               | – | 1994 | – |               |

### SOURCE-DrAIN DIODE CHARACTERISTICS

|                                                    |           |                                                                                      |   |     |     |    |
|----------------------------------------------------|-----------|--------------------------------------------------------------------------------------|---|-----|-----|----|
| Continuous Source-Drain Diode Forward Current      | $I_{SD}$  | $V_{GS} = -5\text{ V}, T_J = 25^\circ\text{C}$                                       | – | –   | 124 | A  |
| Pulsed Source-Drain Diode Forward Current (Note 2) | $I_{SDM}$ |                                                                                      | – | –   | 363 |    |
| Forward Diode Voltage                              | $V_{SD}$  | $V_{GS} = -5\text{ V}, I_{SD} = 60\text{ A}, T_J = 25^\circ\text{C}$                 | – | 4.3 | –   | V  |
| Reverse Recovery Time                              | $t_{RR}$  | $V_{GS} = -5/20\text{ V}, I_{SD} = 60\text{ A}, dI_S/dt = 1000\text{ A}/\mu\text{s}$ | – | 34  | –   | ns |
| Reverse Recovery Charge                            | $Q_{RR}$  |                                                                                      | – | 263 | –   | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Typical Performance

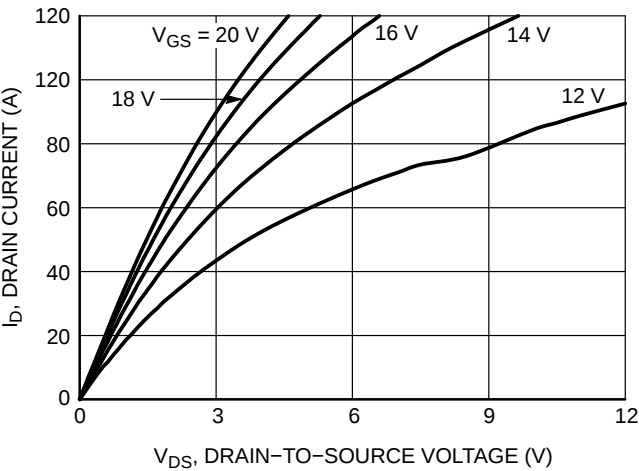


Figure 1. On-Region Characteristics

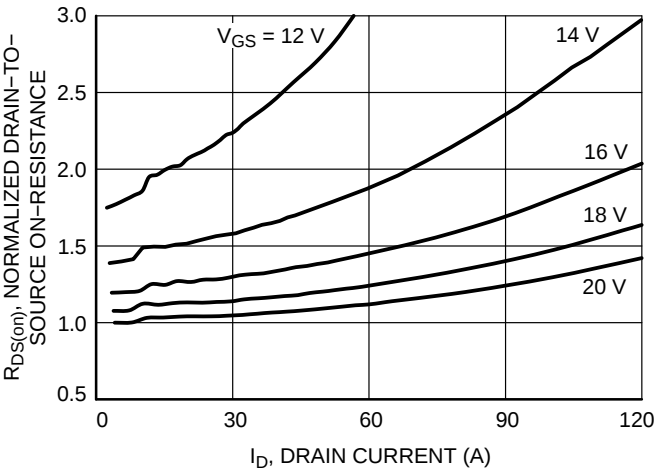


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

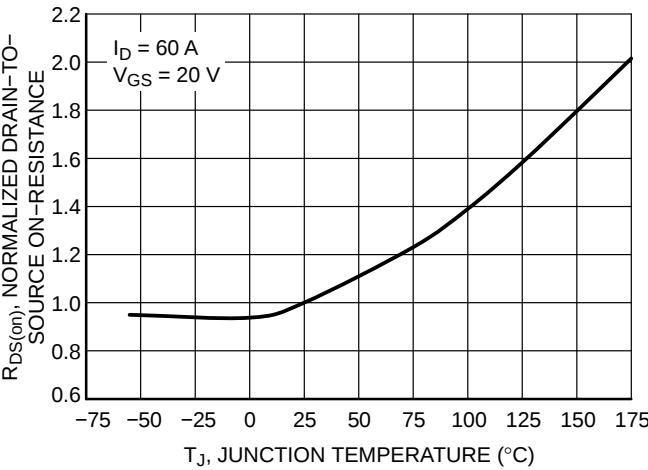


Figure 3. On-Resistance Variation with Temperature

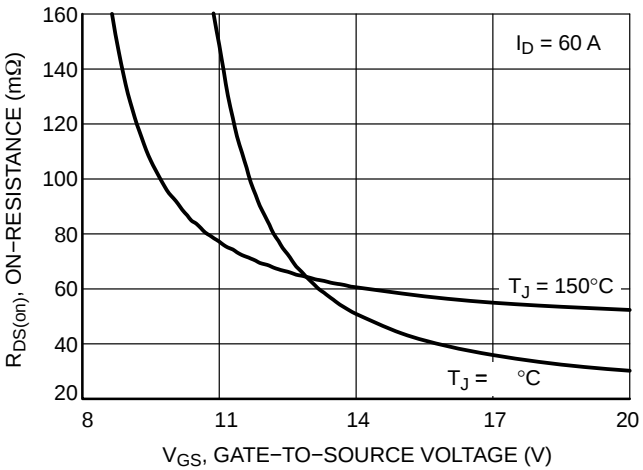


Figure 4. On-Resistance vs. Gate-to-Source Voltage

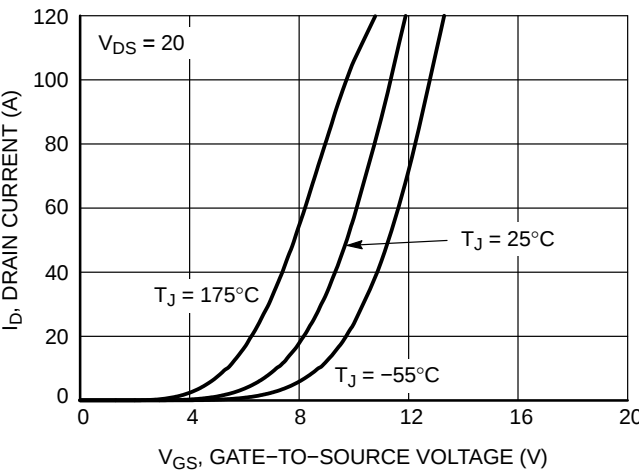


Figure 5. Transfer Characteristics

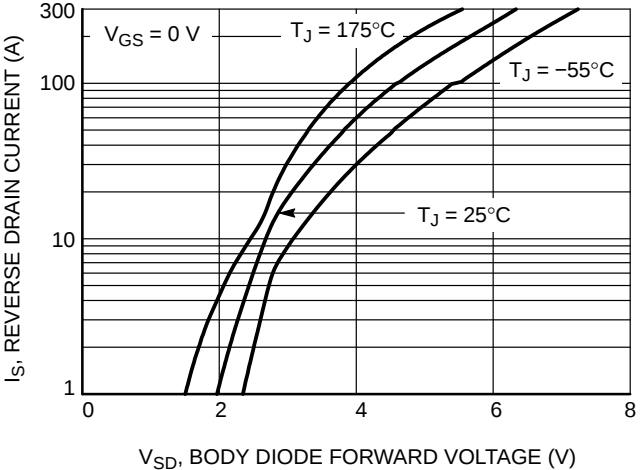


Figure 6. Diode Forward Voltage vs. Current

Typical Performance

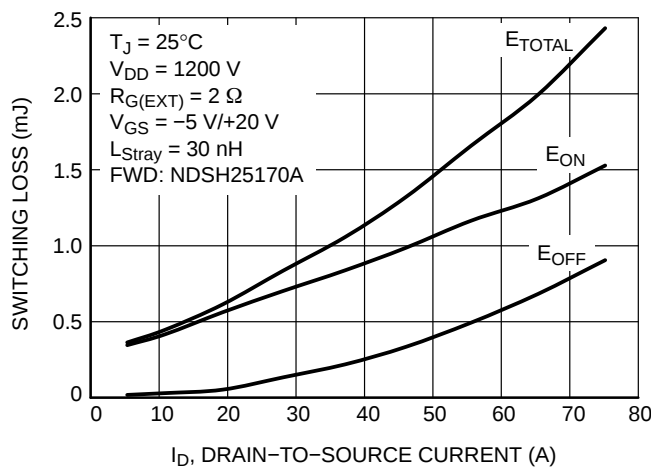


Figure 7. Switching Loss vs. Drain-to-Source Current (25°C)

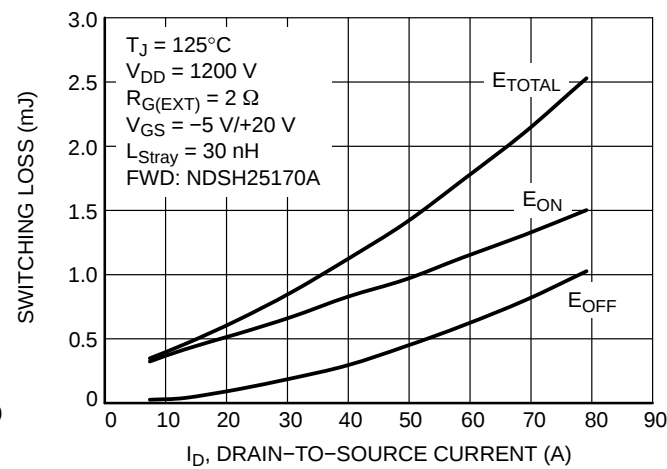


Figure 8. Switching Loss vs. Drain-to-Source Current (125°C)

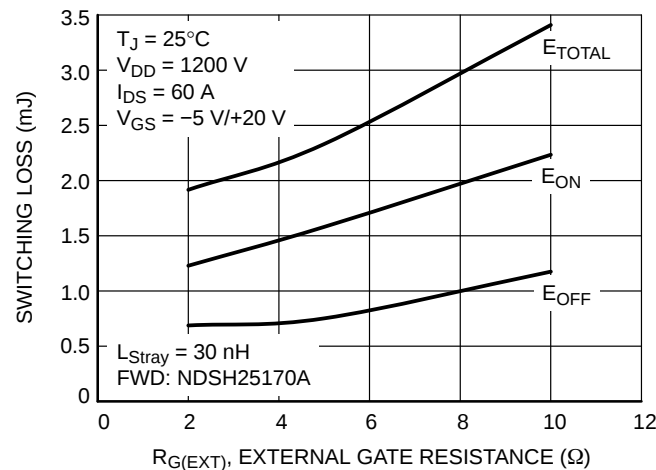


Figure 9. Switching Loss vs. External Gate Resistance

Typical Performance

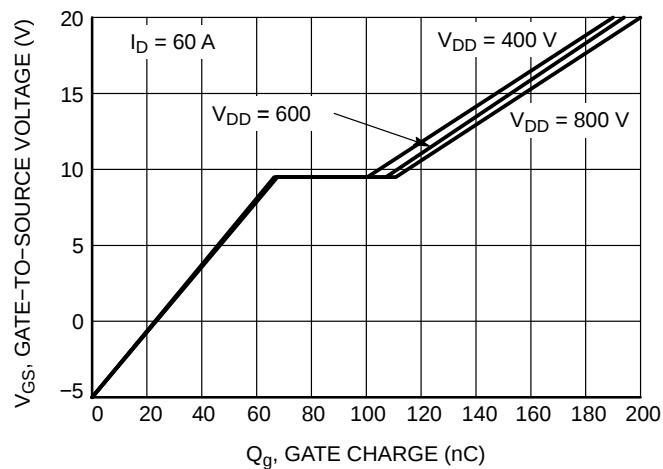


Figure 10. Gate-to-Source Voltage vs. Total Charge

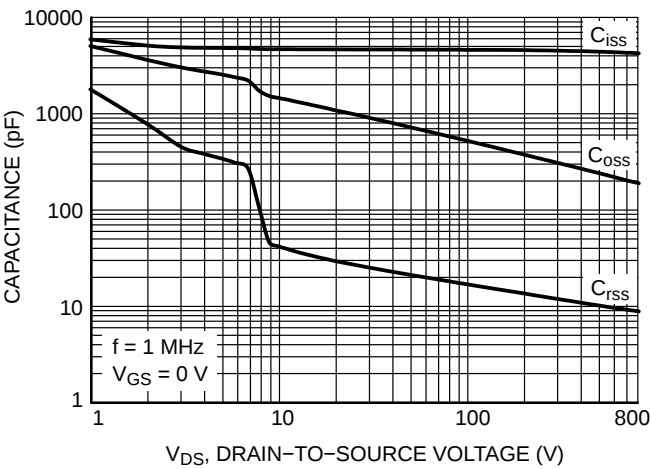


Figure 11. Capacitance vs. Drain-to-Source Voltage

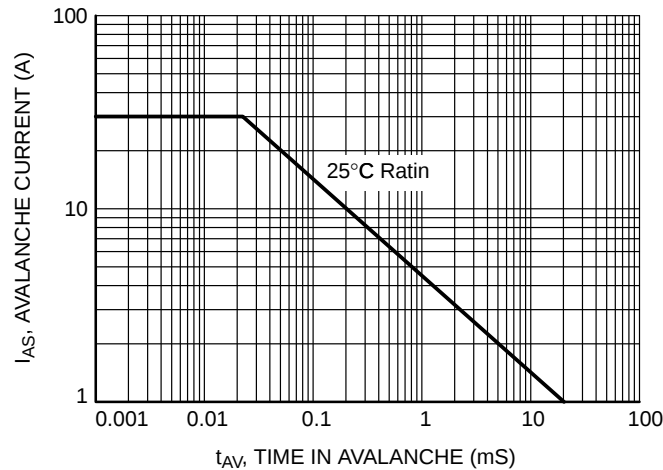


Figure 12. Unclamped Inductive Switching Capability

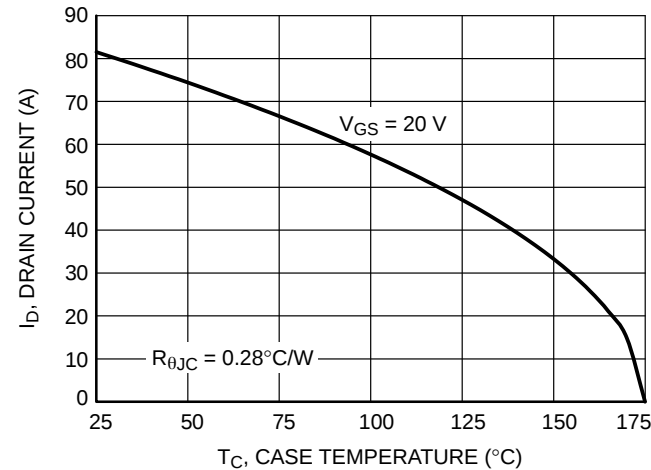


Figure 13. Maximum Continuous Drain Current vs. Case Temperature

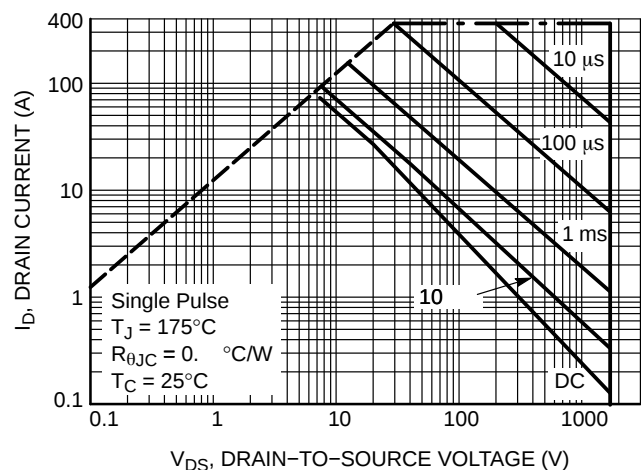


Figure 14. Safe Operating Area

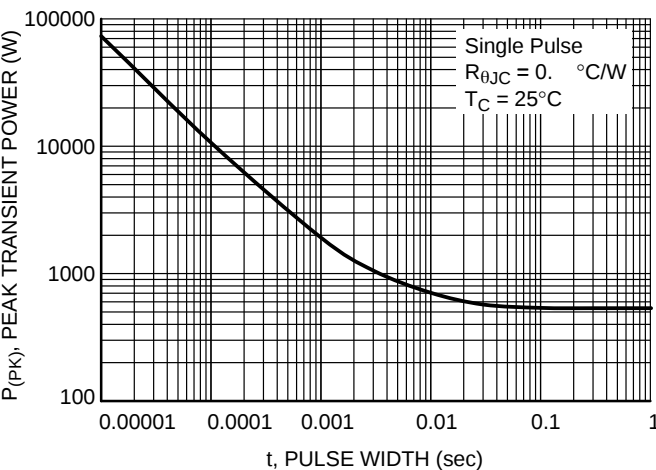


Figure 15. Single Pulse Maximum Power Dissipation

Typical Performance

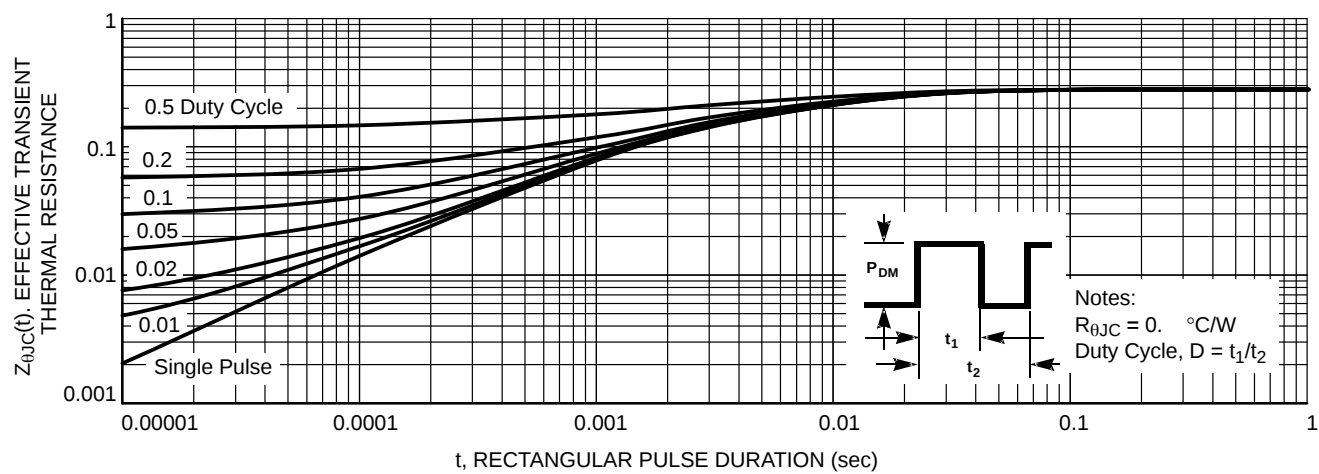


Figure 16. Junction-to-Case Thermal Response